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# Onsemí

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# MOSFET - Power, N-Channel, SUPERFET<sup>®</sup> III, FAST

## 650 V, 250 mΩ, 13 A

# NTPF250N65S3H

## Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provides superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III FAST MOSFET series helps minimize various power systems and improve system efficiency.

## Features

- 700 V @  $T_J = 150^{\circ}C$
- Typ.  $R_{DS(on)} = 201 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 24 nC)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 229 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

## Applications

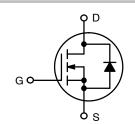
- Computing / Display Power Supplies
- Telecom / Server Power Supplies
- Industrial Power Supplies
- Lighting / Charger / Adapter



## **ON Semiconductor®**

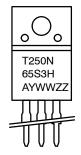
## www.onsemi.com

V <sub>DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX	
650 V	250 m $\Omega$ @ 10 V	13 A	





## MARKING DIAGRAM



T250N65S3H = Specific Device Code

- = Assembly Location
- = Year
- WW = Work Week

А

Υ

ZZ = Lot Code

## ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	Value	Unit V	
V <sub>DSS</sub>	Drain to Source Voltage			650
V <sub>GSS</sub>	Gate to Source Voltage	DC	±30	V
		AC (f > 1 Hz)	±30	V
۱ <sub>D</sub>	Drain Current	Continuous (T <sub>C</sub> = 25°C)	13*	А
		Continuous (T <sub>C</sub> = 100°C)	8*	
I <sub>DM</sub>	Drain Current Pulsed (Note 1)		36*	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		108	mJ
I <sub>AS</sub>	Avalanche Current (Note 2)		2.9	А
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		1.06	mJ
dv/dt	MOSFET dv/dt		120	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C)	29	W
		Derate Above 25°C	0.23	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 s		260	°C

## ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. \*Drain current limited by maximum junction temperature.

1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 2.9 \text{ A}, R_G = 25 \Omega$ , starting  $T_J = 25^{\circ}\text{C}$ . 3.  $I_{SD} \le 6.5 \text{ A}$ , di/dt  $\le 200 \text{ A/}\mu\text{s}$ ,  $V_{DD} \le 400 \text{ V}$ , starting  $T_J = 25^{\circ}\text{C}$ .

## **THERMAL CHARACTERISTICS**

Symbol	mbol Parameter		Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	4.23	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

## PACKAGE MARKING AND ORDERING INFORMATION

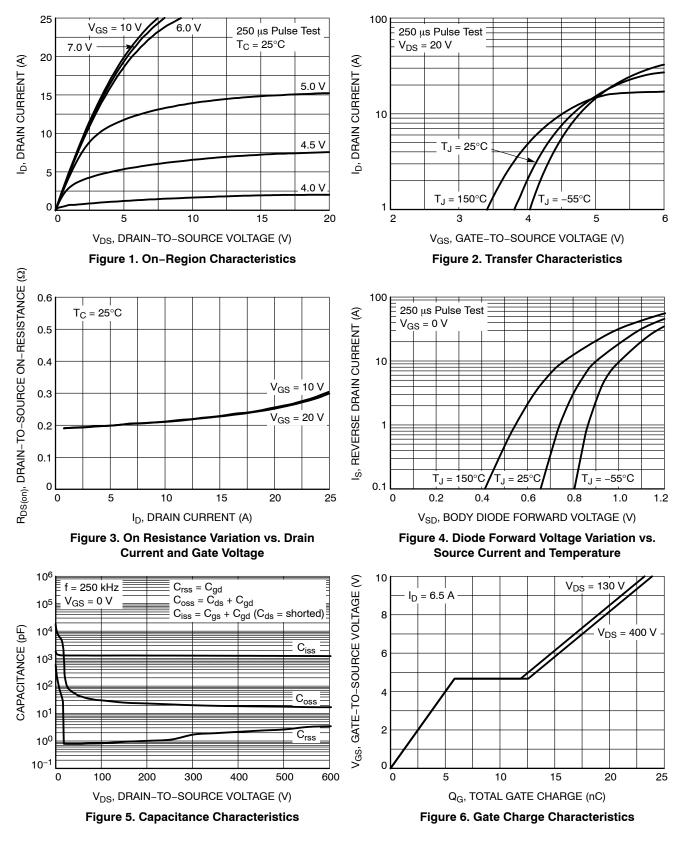
Part Number	Top Marking	Package	Shipping
NTPF250N65S3H	T250N65S3H	TO-220 FULLPAK	50 Units / Tube

#### FI FOTRICAL CHARACTERISTICS (T 25°C uplease otherwise noted)

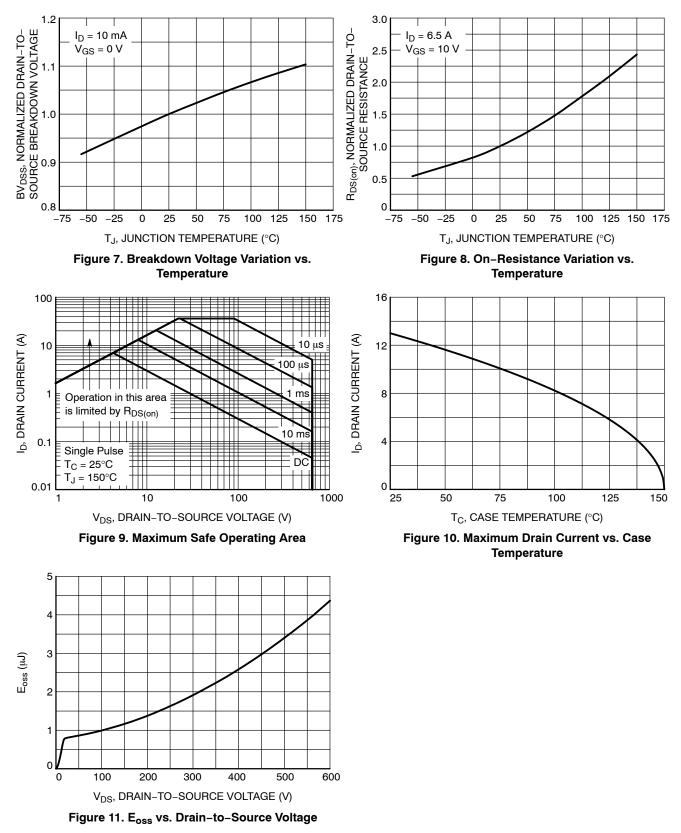
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C	650			V
		$V_{GS}$ = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 150°C	700			V
$\Delta \text{BV}_{\text{DSS}}\!/\!\Delta\text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 10 mA, Referenced to 25°C		0.63		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS}$ = 650 V, $V_{GS}$ = 0 V			1	μA
		$V_{DS}$ = 520 V, $T_C$ = 125°C		0.7		
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS}$ = ±30 V, $V_{DS}$ = 0 V			±100	nA
N CHARACTE	RISTICS					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1.1 \text{ mA}$	2.4		4.0	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS}$ = 10 V, I <sub>D</sub> = 6.5 A		201	250	mΩ
9fs	Forward Transconductance	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 6.5 A		14		S
YNAMIC CHA	RACTERISTICS					
C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 400 V, $V_{GS}$ = 0 V, f = 250 kHz		1261		pF
C <sub>oss</sub>	Output Capacitance			19		pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V		229		pF
C <sub>oss(er.)</sub>	Energy Related Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V		33		pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V			24		nC
Q <sub>gs</sub>	Gate to Source Gate Charge	V <sub>DS</sub> = 400 V, I <sub>D</sub> = 6.5 A, V <sub>GS</sub> = 10 V (Note 4)		5.9		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	(1010-1)		6.8		nC
ESR	Equivalent Series Resistance	f = 1 MHz		0.9		Ω
WITCHING CH	IARACTERISTICS					
t <sub>d(on)</sub>	Turn-On Delay Time			18		ns
t <sub>r</sub>	Turn-On Rise Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 6.5 \text{ A},$		8.2		ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$\begin{array}{c} {\sf V}_{\rm DD} = 400 \; {\sf V}, \; {\sf I}_{\rm D} = 6.5 \; {\sf A}, \\ {\sf V}_{\rm GS} = 10 \; {\sf V}, \; {\sf R}_{\rm g} = 12 \; \Omega \\ \qquad \qquad$		54		ns
t <sub>f</sub>	Turn-Off Fall Time			4.2		ns
OURCE-DRAI	N DIODE CHARACTERISTICS					
۱ <sub>S</sub>	Maximum Continuous Source to Drain Diode Forward Current				13	Α
I <sub>SM</sub>	Maximum Pulsed Source to Drain Diode Forward Current				36	Α
$V_{SD}$	Source to Drain Diode Forward Voltage	$V_{GS}$ = 0 V, $I_{SD}$ = 6.5 A			1.2	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>DD</sub> = 400 V, I <sub>SD</sub> = 6.5 A,		233	1	ns
Q <sub>rr</sub>	Reverse Recovery Charge	dl <sub>F</sub> /dt = 100 A/μs		2.5		μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

## **TYPICAL CHARACTERISTICS**



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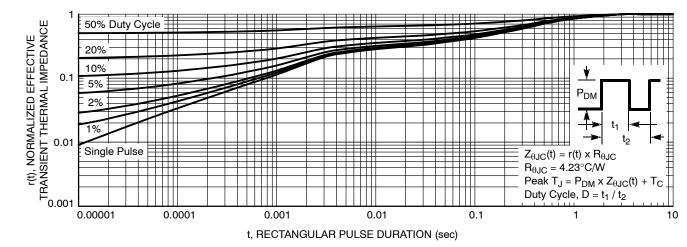
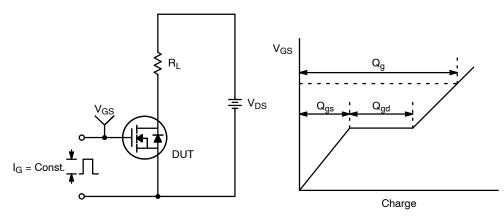


Figure 12. Transient Thermal Response Curve





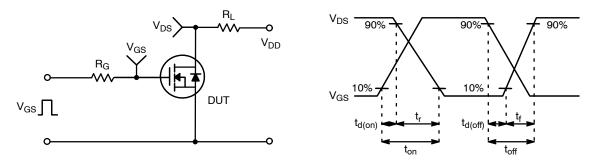


Figure 14. Resistive Switching Test Circuit & Waveforms

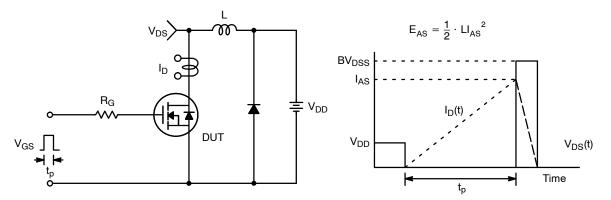


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

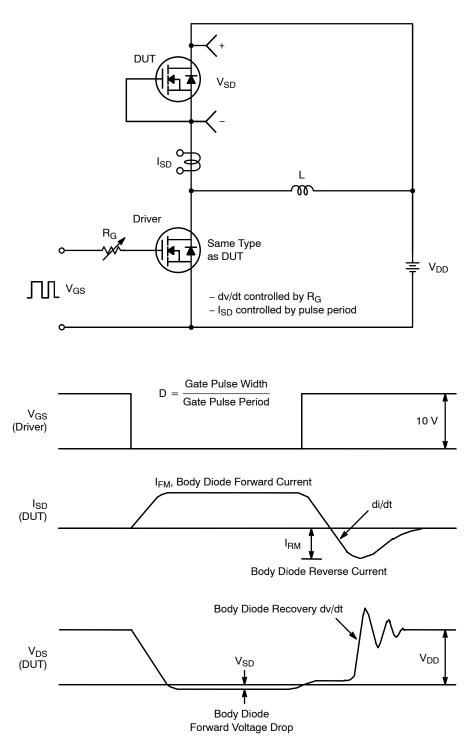
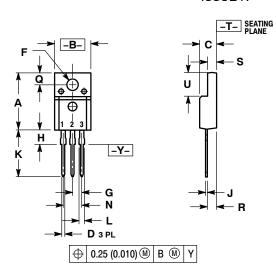


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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## PACKAGE DIMENSIONS

### **TO-220 FULLPAK** CASE 221D-03 ISSUE K



NOTES

1. DIMENSIONING AND TOLERANCING PER ANSI Y14 5M 1982

CONTROLLING DIMENSION: INCH 221D-01 THRU 221D-02 OBSOLETE, NEW STANDARD 221D-03. 3.

	INCHES		MILLIN	LIMETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.617	0.635	15.67	16.12	
В	0.392	0.419	9.96	10.63	
С	0.177	0.193	4.50	4.90	
D	0.024	0.039	0.60	1.00	
F	0.116	0.129	2.95	3.28	
G	0.100 BSC		2.54 BSC		
Н	0.118	0.135	3.00	3.43	
J	0.018	0.025	0.45	0.63	
Κ	0.503	0.541	12.78	13.73	
L	0.048	0.058	1.23	1.47	
Ν	0.200 BSC		5.08 BSC		
Q	0.122	0.138	3.10	3.50	
R	0.099	0.117	2.51	2.96	
S	0.092	0.113	2.34	2.87	
U	0.239	0.271	6.06	6.88	

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